



Product Change Notification - SYST-180XPD053

Date:

23 Mar 2020

Product Category:

Memory

Affected CPNs:



Notification subject:

Data Sheet - AT28C010 Industrial - Complete Datasheet

Notification text:

SYST-180XPD053

Microchip has released a new Product Documents for the AT28C010 Industrial - Complete Datasheet of devices. If you are using one of these devices please read the document located at [AT28C010 Industrial - Complete Datasheet](#).

Notification Status: Final

Description of Change: 1) Updated to the Microchip template. Microchip DS20006331 replaces Atmel document 0353. 2) Added marking details and product identification system details.

Impacts to Data Sheet: None

Reason for Change: Conversion of Atmel datasheet to Microchip datasheet conventions.

Change Implementation Status: Complete

Date Document Changes Effective: 23 Jan 2020

NOTE: Please be advised that this is a change to the document only the product has not been changed.

Markings to Distinguish Revised from Unrevised Devices: N/A

Attachment(s):

[AT28C010 Industrial - Complete Datasheet](#)

Please contact your local [Microchip sales office](#) with questions or concerns regarding this notification.

Terms and Conditions:

If you wish to receive Microchip PCNs via email please register for our PCN email service at our [PCN home page](#) select register then fill in the required fields. You will find instructions about registering for Microchips PCN email service in the [PCN FAQ](#) section.

If you wish to change your PCN profile, including opt out, please go to the [PCN home page](#) select login and sign into your myMicrochip account. Select a profile option from the left navigation bar and make the applicable selections.



1-Megabit (128K x 8) Paged Parallel EEPROM

Features

- Fast Read Access Time: 120 ns
- Automatic Page Write Operation:
 - Internal address and data latches for 128 bytes
 - Internal control timer
- Fast Write Cycle Time:
 - Page Write cycle time: 10 ms maximum
 - 1 to 128-byte Page Write operation
- Low-Power Dissipation:
 - 40 mA active current
 - 200 μ A CMOS standby current
- Hardware and Software Data Protection
- $\overline{\text{DATA}}$ Polling for End of Write Detection
- High Reliability CMOS Technology:
 - Endurance: 10,000 or 100,000 cycles
 - Data retention: 10 years
- Single 5V \pm 10% Supply
- CMOS and TTL Compatible Inputs and Outputs
- JEDEC[®] Approved Byte-Wide Pinout
- Industrial Temperature Ranges
- Green (Pb/Halide-free) Packaging Option Only

Packages

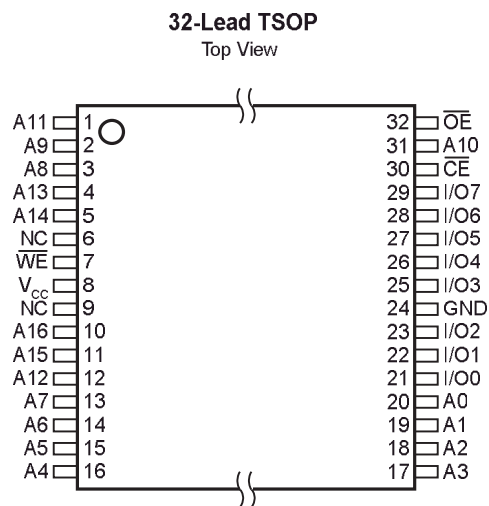
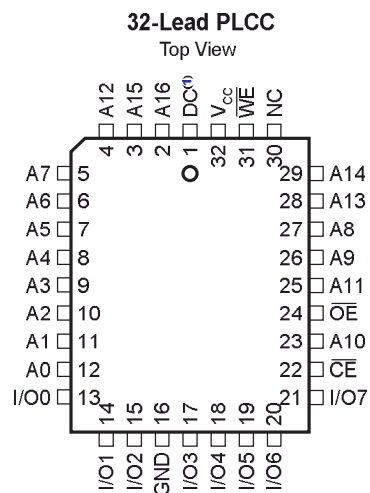
- 32-Lead PLCC, 32-Lead TSOP

Table of Contents

Features.....	1
Packages.....	1
1. Package Types (not to scale).....	4
2. Pin Descriptions.....	5
3. Description.....	6
3.1. Block Diagram.....	6
4. Electrical Characteristics.....	7
4.1. Absolute Maximum Ratings.....	7
4.2. DC and AC Operating Range.....	7
4.3. DC Characteristics.....	7
4.4. Pin Capacitance.....	8
5. Device Operation.....	9
5.1. Operating Modes.....	10
5.2. AC Read Characteristics.....	10
5.3. AC Read Waveforms.....	11
5.4. Input Test Waveforms and Measurement Level.....	11
5.5. Output Test Load.....	12
5.6. AC Write Characteristics.....	12
5.7. AC Write Waveforms.....	13
5.8. Page Mode Characteristics.....	14
5.9. Page Mode Write Waveforms ^(1,2)	14
5.10. Chip Erase Waveforms.....	15
5.11. Software Data Protection Enable Algorithm ⁽¹⁾	16
5.12. Software Data Protection Disable Algorithm ⁽¹⁾	17
5.13. Software Protected Program Cycle Waveform ^(1,2,3)	18
5.14. $\overline{\text{Data}}$ Polling Characteristics ⁽¹⁾	18
5.15. $\overline{\text{Data}}$ Polling Waveforms.....	19
5.16. Toggle Bit Characteristics ⁽¹⁾	19
5.17. Toggle Bit Waveforms.....	19
6. Packaging Information.....	21
6.1. Package Marking Information.....	21
7. Revision History.....	24
The Microchip Website.....	25
Product Change Notification Service.....	25
Customer Support.....	25
Product Identification System.....	26
Microchip Devices Code Protection Feature.....	27

Legal Notice.....	27
Trademarks.....	27
Quality Management System.....	28
Worldwide Sales and Service.....	29

1. Package Types (not to scale)



Note 1: PLCC package pin 1 is Don't Connect.

2. Pin Descriptions

The descriptions of the pins are listed in [Table 2-1](#).

Table 2-1. Pin Function Table

Name	32-Lead PLCC	32-Lead TSOP	Function
DC	1	—	Don't Connect
A16	2	10	Address
A15	3	11	Address
A12	4	12	Address
A7	5	13	Address
A6	6	14	Address
A5	7	15	Address
A4	8	16	Address
A3	9	17	Address
A2	10	18	Address
A1	11	19	Address
A0	12	20	Address
I/O0	13	21	Data Input/Output
I/O1	14	22	Data Input/Output
I/O2	15	23	Data Input/Output
GND	16	24	Ground
I/O3	17	25	Data Input/Output
I/O4	18	26	Data Input/Output
I/O5	19	27	Data Input/Output
I/O6	20	28	Data Input/Output
I/O7	21	29	Data Input/Output
\overline{CE}	22	30	Chip Enable
A10	23	31	Address
\overline{OE}	24	32	Output Enable
A11	25	1	Address
A9	26	2	Address
A8	27	3	Address
A13	28	4	Address
A14	29	5	Address
NC	30	6, 9	No Connect
\overline{WE}	31	7	Write Enable
V _{CC}	32	8	Device Power Supply

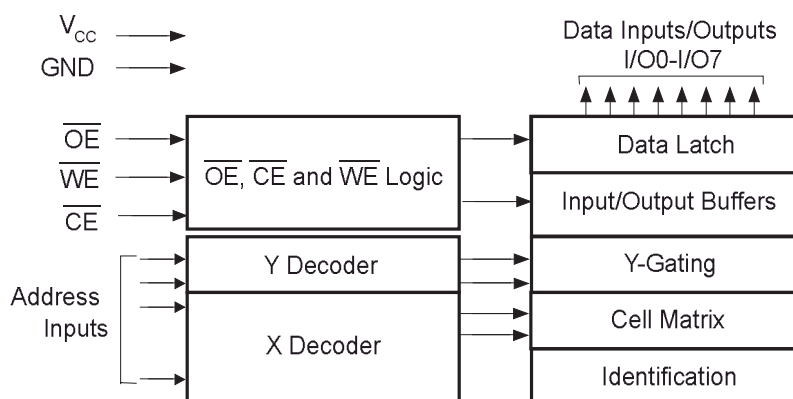
3. Description

The AT28C010 is a high-performance Electrically Erasable and Programmable Read-Only Memory (EEPROM). Its 1-Mb memory is organized as 131,072 words by 8 bits. Manufactured with Microchip's advanced nonvolatile CMOS technology, the device offers access times of 120 ns with power dissipation of just 220 mW. When the device is deselected, the CMOS standby current is less than 200 μ A.

The AT28C010 is accessed like a Static RAM for the read or write cycle without the need for external components. The device contains a 128-byte page register to allow writing of up to 128 bytes simultaneously. During a write cycle, the address and 1 to 128 bytes of data are internally latched, freeing the address and data bus for other operations. Following the initiation of a write cycle, the device will automatically write the latched data using an internal control timer. The end of a write cycle can be detected by $\overline{\text{DATA}}$ Polling of I/O7. Once the end of a write cycle has been detected, a new access for a read or write can begin.

The AT28C010 has additional features to ensure high quality and manufacturability. The device utilizes internal error correction for extended endurance and improved data retention characteristics. An optional software data protection mechanism is available to guard against inadvertent writes. The device also includes an extra 128 bytes of EEPROM for device identification or tracking.

3.1 Block Diagram



4. Electrical Characteristics

4.1 Absolute Maximum Ratings

Temperature under bias	-55°C to +125°C
Storage temperature	-65°C to +150°C
All input voltages (including NC pins) with respect to ground	-0.6V to +6.25V
All output voltages with respect to ground	-0.6V to $V_{CC} + 0.6V$
Voltage on \overline{OE} and A9 with respect to ground	-0.6V to +13.5V

Note: Stresses above those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

4.2 DC and AC Operating Range

Table 4-1. DC and AC Operating Range

		AT28C010-12	AT28C010-15
Operating Temperature (Case)	Industrial	-40°C to +85°C	-40°C to +85°C
V_{CC} Power Supply		5V \pm 10%	5V \pm 10%

4.3 DC Characteristics

Table 4-2. DC Characteristics

Parameter	Symbol	Minimum	Maximum	Units	Test Conditions
Input Load Current	I_{LI}	—	10	μA	$V_{IN} = 0V$ to $V_{CC} + 1V$
Output Leakage Current	I_{LO}	—	10	μA	$V_{IO} = 0V$ to V_{CC}
V_{CC} Standby Current CMOS	I_{SB1}	—	200	μA	$\overline{CE} = V_{CC} - 0.3V$ to $V_{CC} + 1V$
V_{CC} Standby Current TTL	I_{SB2}	—	3	mA	$\overline{CE} = 2.0V$ to $V_{CC} + 1V$
V_{CC} Active Current	I_{CC}	—	40	mA	$f = 5\text{ MHz}$; $I_{OUT} = 0\text{ mA}$
Input Low Voltage	V_{IL}	—	0.8	V	
Input High Voltage	V_{IH}	2.0	—	V	
Output Low Voltage	V_{OL}	—	0.45	V	$I_{OL} = 2.1\text{ mA}$
Output High Voltage	V_{OH1}	2.4	—	V	$I_{OH} = -400\text{ }\mu A$
Output High Voltage CMOS	V_{OH2}	4.2	—	V	$I_{OH} = -100\text{ }\mu A$; $V_{CC} = 4.5V$

4.4 Pin Capacitance

Table 4-3. Pin Capacitance^(1,2)

Symbol	Typical	Maximum	Units	Conditions
C_{IN}	4	10	pF	$V_{IN} = 0V$
C_{OUT}	8	12	pF	$V_{OUT} = 0V$

Note:

1. This parameter is characterized but is not 100% tested in production.
2. $f = 1\text{ MHz}$, $T_A = 25^\circ\text{C}$

5. Device Operation

READ: The AT28C010 is accessed like a Static RAM. When \overline{CE} and \overline{OE} are low and \overline{WE} is high, the data stored at the memory location determined by the address pins is asserted on the outputs. The outputs are put in the high-impedance state when either \overline{CE} or \overline{OE} is high. This dual-line control gives designers flexibility in preventing bus contention in their system.

BYTE WRITE: A low pulse on the \overline{WE} or \overline{CE} input with \overline{CE} or \overline{WE} low (respectively) and \overline{OE} high initiates a write cycle. The address is latched on the falling edge of \overline{CE} or \overline{WE} , whichever occurs last. The data is latched by the first rising edge of \overline{CE} or \overline{WE} . Once a byte write is started, it will automatically time itself to completion. Once a programming operation is initiated and for the duration of t_{WC} , a read operation will effectively be a polling operation.

PAGE WRITE: The page write operation of the AT28C010 allows 1 to 128-byte of data to be written into the device during a single internal programming period. A page write operation is initiated in the same manner as a byte write; the first byte written can then be followed by 1 to 127 additional bytes. Each successive byte must be written within 150 μ s (t_{BLC}) of the previous byte. If the t_{BLC} limit is exceeded, the AT28C010 will cease accepting data and commence the internal programming operation. All bytes during a page write operation must reside on the same page as defined by the state of the A7-A16 inputs. For each \overline{WE} high-to-low transition during the page write operation, A7-A16 must be the same. The A0 to A6 inputs are used to specify which bytes within the page are to be written. The bytes may be loaded in any order and may be altered within the same load period. Only bytes which are specified for writing will be written; unnecessary cycling of other bytes within the page does not occur.

DATA POLLING: The AT28C010 features \overline{DATA} Polling to indicate the end of a write cycle. During a byte or page write cycle, an attempted read of the last byte written will result in the complement of the written data to be presented on I/O7. Once the write cycle has been completed, true data is valid on all outputs, and the next write cycle may begin. \overline{DATA} Polling may begin at anytime during the write cycle.

TOGGLE BIT: In addition to \overline{DATA} Polling, the AT28C010 provides another method for determining the end of a write cycle. During the write operation, successive attempts to read data from the device will result in I/O6 toggling between one and zero. Once the write has completed, I/O6 will stop toggling and valid data will be read. Reading the toggle bit may begin at any time during the write cycle.

DATA PROTECTION: If precautions are not taken, inadvertent writes may occur during transitions of the host system power supply. Microchip incorporated both hardware and software features that will protect the memory against inadvertent writes.

HARDWARE PROTECTION: Hardware features protect against inadvertent writes to the AT28C010 in the following ways:

- V_{CC} sense – if V_{CC} is below 3.8V (typical), the write function is inhibited
- V_{CC} power-on delay – once V_{CC} has reached 3.8V, the device will automatically time out 5 ms (typical) before allowing a write
- write inhibit – holding any one of \overline{OE} low, \overline{CE} high or \overline{WE} high inhibits write cycles
- noise filter – pulses of less than 15 ns (typical) on the \overline{WE} or \overline{CE} inputs will not initiate a write cycle

SOFTWARE DATA PROTECTION: A software-controlled data protection feature has been implemented on the AT28C010. When enabled, the software data protection (SDP) will prevent inadvertent writes. The SDP feature may be enabled or disabled by the user; the AT28C010 is shipped with SDP disabled.

SDP is enabled by the host system issuing a series of three write commands; three specific bytes of data are written to three specific addresses (refer to Software Data Protection Algorithm). After writing the 3-byte command sequence and after t_{WC} , the entire AT28C010 will be protected against inadvertent write operations. It should be noted that, once protected, the host may still perform a byte or page write to the AT28C010. This is done by preceding the data to be written by the same 3-byte command sequence used to enable SDP.

Once set, SDP will remain active unless the disable command sequence is issued. Power transitions do not disable SDP and SDP will protect the AT28C010 during power-up and power-down conditions. All command sequences must conform to the page write timing specifications. The data in the enable and disable command sequences is not written to the device and the memory addresses used in the sequence may be written with data in either a byte or page write operation.

After setting SDP, any attempt to write to the device without the 3-byte command sequence will start the internal write timers. No data will be written to the device; however, for the duration of t_{WC} , read operations will effectively be polling operations.

DEVICE IDENTIFICATION: An extra 128 of EEPROM memory are available to the user for device identification. By raising A9 to $12V \pm 0.5V$ and using address locations 1FF80H to 1FFFFH, the bytes may be written to or read from in the same manner as the regular memory array.

OPTIONAL CHIP ERASE MODE: The entire device can be erased using a 6-byte software code. See Software Chip Erase application note for details.

5.1 Operating Modes

Table 5-1. Operating Modes

Mode	\overline{CE}	\overline{OE}	WE	I/O
Read	V_{IL}	V_{IL}	V_{IH}	D_{OUT}
Write ⁽¹⁾	V_{IL}	V_{IH}	V_{IL}	D_{IN}
Standby/Write Inhibit	V_{IH}	$X^{(2)}$	X	High-Z
Write Inhibit	X	X	V_{IH}	
Write Inhibit	X	V_{IL}	X	
Output Disable	X	V_{IH}	X	High-Z

Note:

1. Refer to AC Programming Waveforms.
2. X can be V_{IL} or V_{IH} .

5.2 AC Read Characteristics

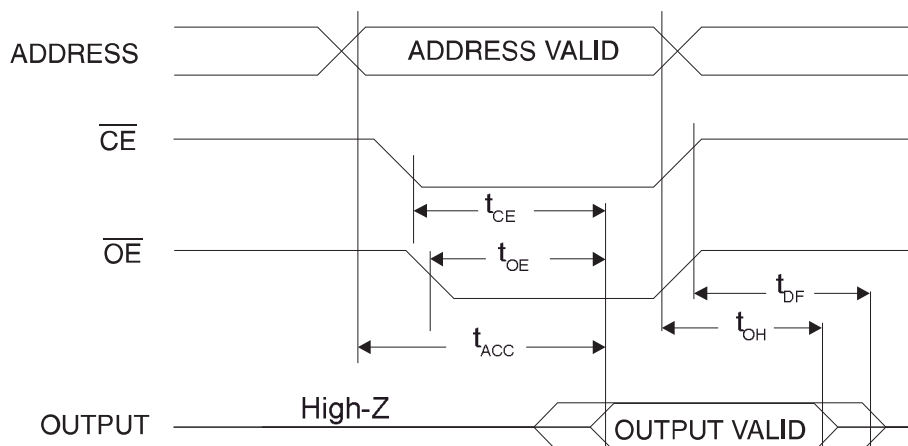
Table 5-2. AC Read Characteristics

Parameter	Symbol	AT28C010-12		AT28C010-15		Units
		Min.	Max.	Min.	Max.	
Address to Output Delay	t_{ACC}	—	120	—	150	ns
\overline{CE} to Output Delay	$t_{CE}^{(1)}$	—	120	—	150	ns
\overline{OE} to Output Delay	$t_{OE}^{(2)}$	0	50	0	55	ns
\overline{CE} or \overline{OE} to Output Float	$t_{DF}^{(3,4)}$	0	50	0	55	ns
Output Hold from \overline{OE} , \overline{CE} or Address, whichever occurred first	t_{OH}	0	—	0	—	ns
\overline{CE} Pulse High Time	$t_{CEPH}^{(5)}$	50	—	50	—	ns

Note:

1. \overline{CE} may be delayed up to $t_{ACC} - t_{CE}$ after the address transition without impact on t_{ACC} .
2. \overline{OE} may be delayed up to $t_{CE} - t_{OE}$ after the falling edge of \overline{CE} without impact on t_{CE} or by $t_{ACC} - t_{OE}$ after an address change without impact in t_{ACC} .
3. t_{DF} is specified from \overline{OE} or \overline{CE} whichever occurs first ($C_L = 5$ pF).
4. This parameter is characterized and is not 100% tested.
5. If \overline{CE} is de-asserted, it must remain de-asserted for at least 50 ns during read operations otherwise incorrect data may be read.

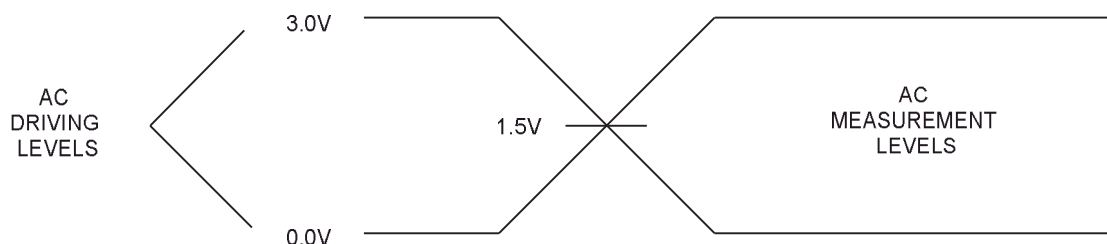
5.3 AC Read Waveforms



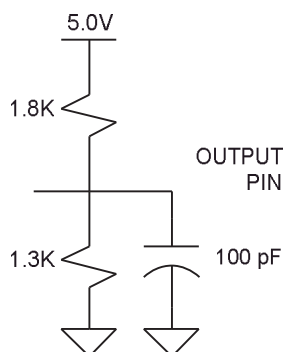
Note:

1. \overline{CE} may be delayed up to $t_{ACC} - t_{CE}$ after the address transition without impact on t_{ACC} .
2. \overline{OE} may be delayed up to $t_{CE} - t_{OE}$ after the falling edge of \overline{CE} without impact on t_{CE} or by $t_{ACC} - t_{OE}$ after an address change without impact on t_{ACC} .
3. t_{DF} is specified from \overline{OE} or \overline{CE} whichever occurs first ($C_L = 5$ pF).
4. This parameter is characterized and is not 100% tested.
5. If \overline{CE} is de-asserted, it must remain de-asserted for at least 50 ns during read operations otherwise incorrect data may be read.

5.4 Input Test Waveforms and Measurement Level



5.5 Output Test Load



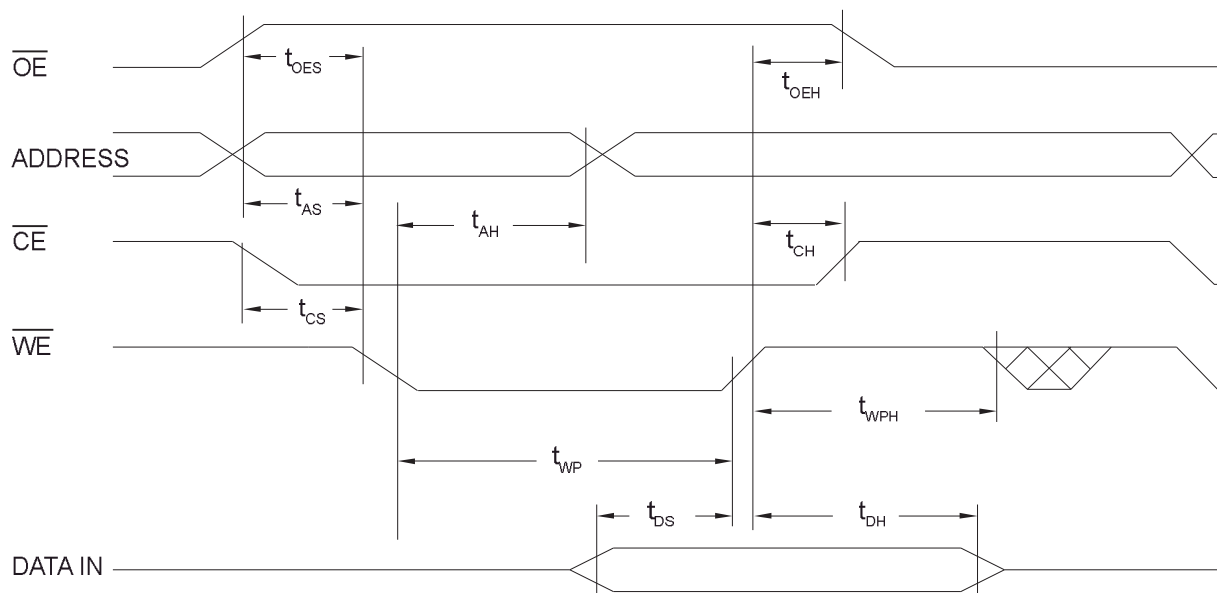
5.6 AC Write Characteristics

Table 5-3. AC Write Characteristics

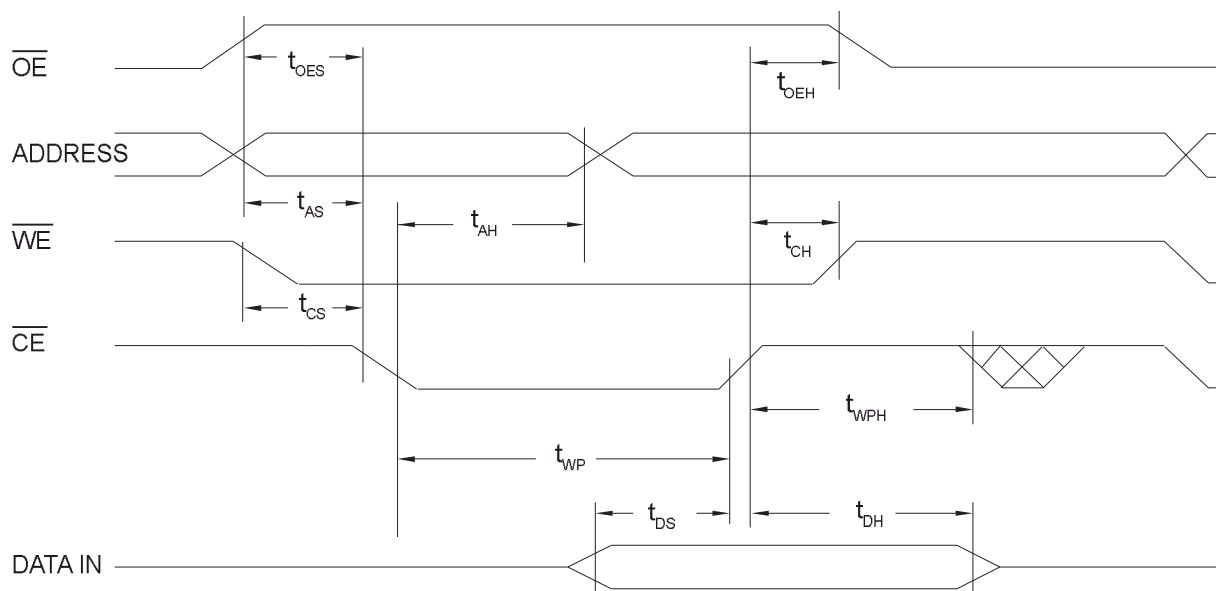
Parameter	Symbol	Minimum	Maximum	Units
Address, $\overline{\text{OE}}$ Set-Up Time	$t_{\text{AS}}, t_{\text{OES}}$	0	—	ns
Address Hold Time	t_{AH}	50	—	ns
Chip Select Set-Up Time	t_{CS}	0	—	ns
Chip Select Hold Time	t_{CH}	0	—	ns
Write Pulse Width ($\overline{\text{WE}}$ or $\overline{\text{CE}}$)	t_{WP}	100	—	ns
Data Set-Up Time	t_{DS}	50	—	ns
Data, $\overline{\text{OE}}$ Hold Time	$t_{\text{DH}}, t_{\text{OEH}}$	0	—	ns

5.7 AC Write Waveforms

5.7.1 $\overline{\text{WE}}$ Controlled



5.7.2 $\overline{\text{CE}}$ Controlled

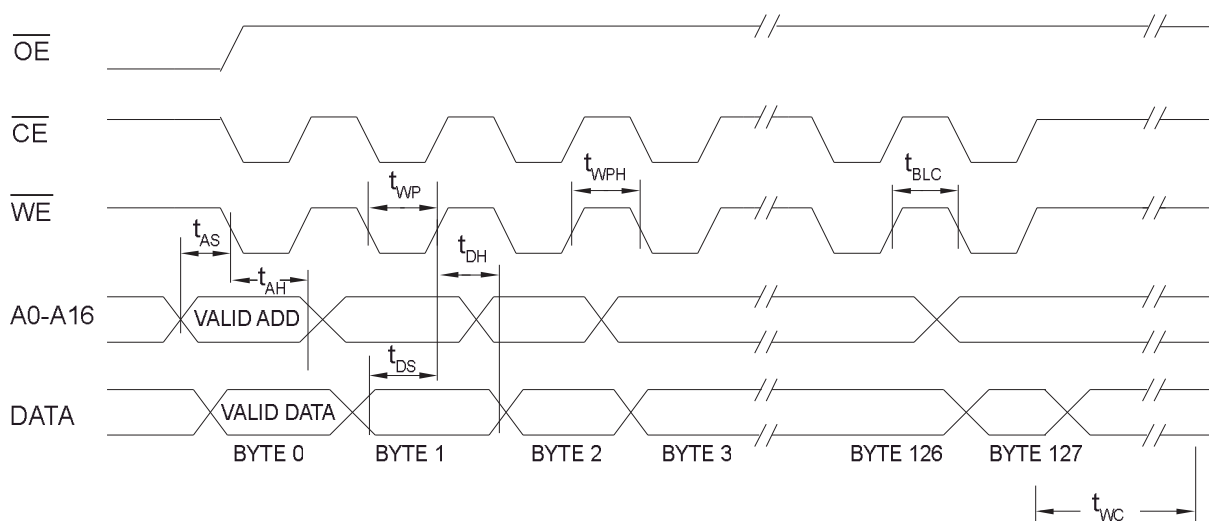


5.8 Page Mode Characteristics

Table 5-4. Page Mode Characteristics

Parameter	Symbol	Minimum	Maximum	Units
Write Cycle Time	t_{WC}	—	10	ms
Address Set-Up Time	t_{AS}	0	—	ns
Address Hold Time	t_{AH}	50	—	ns
Data Set-Up Time	t_{DS}	50	—	ns
Data Hold Time	t_{DH}	0	—	ns
Write Pulse Width	t_{WP}	100	—	ns
Byte Load Cycle Time	t_{BLC}	—	150	μ s
Write Pulse Width High	t_{WPH}	50	—	ns

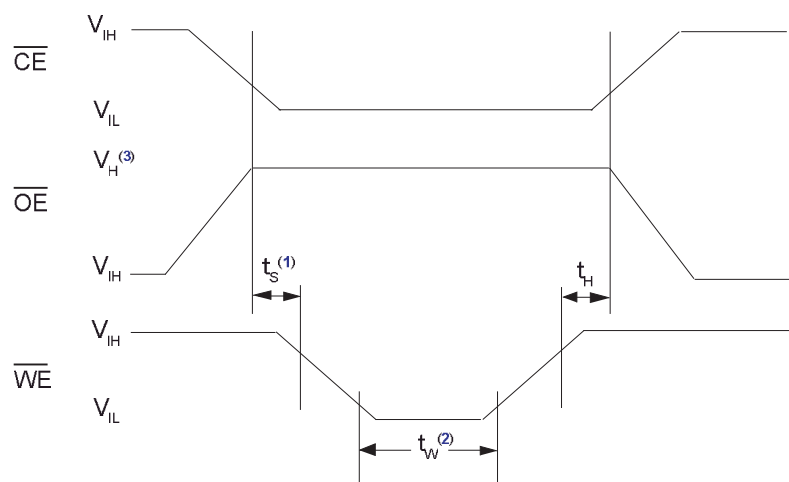
5.9 Page Mode Write Waveforms^(1,2)



Note:

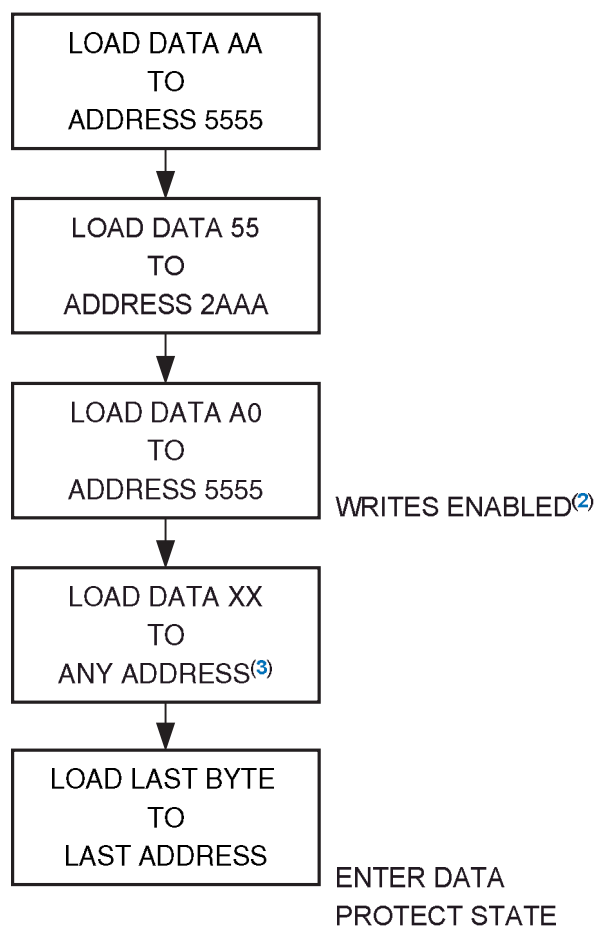
1. A7 through A16 must specify the page address during each high-to-low transition of \overline{WE} (or \overline{CE}).
2. \overline{OE} must be high only when \overline{WE} and \overline{CE} are both low.

5.10 Chip Erase Waveforms

**Note:**

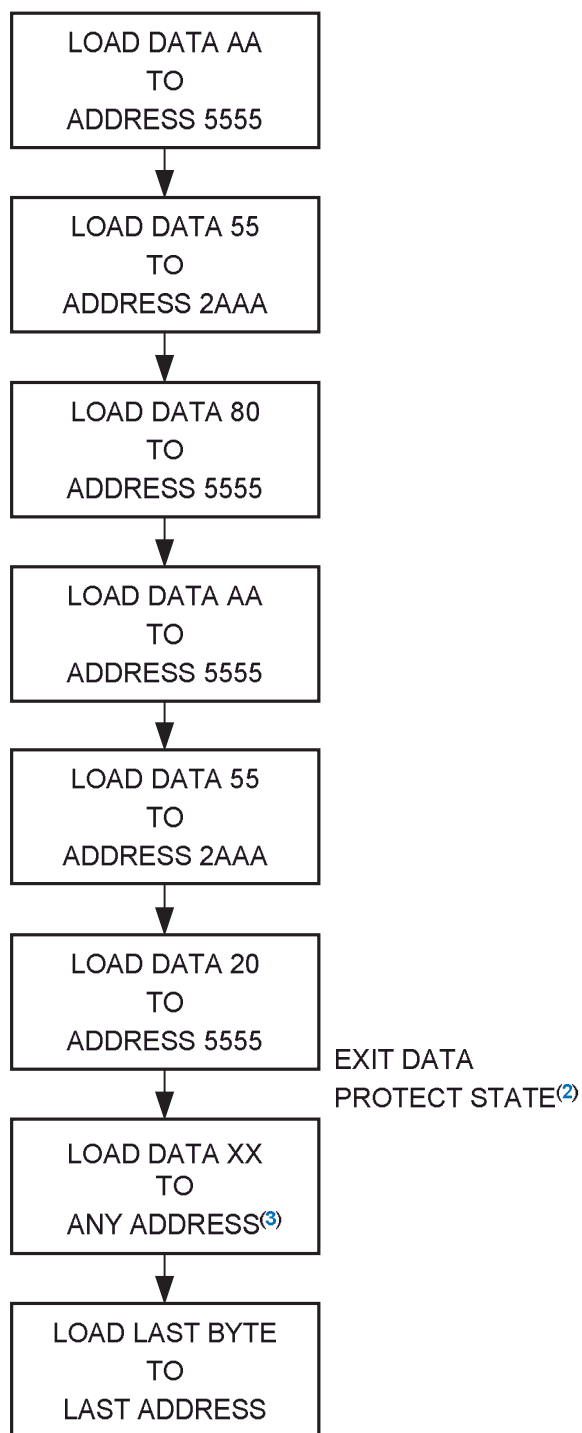
1. $t_S = 5$ msec (minimum)
2. $t_W = t_H = 10$ msec (minimum)
3. $V_H = 12.0V \pm 0.5V$

5.11 Software Data Protection Enable Algorithm⁽¹⁾

**Note:**

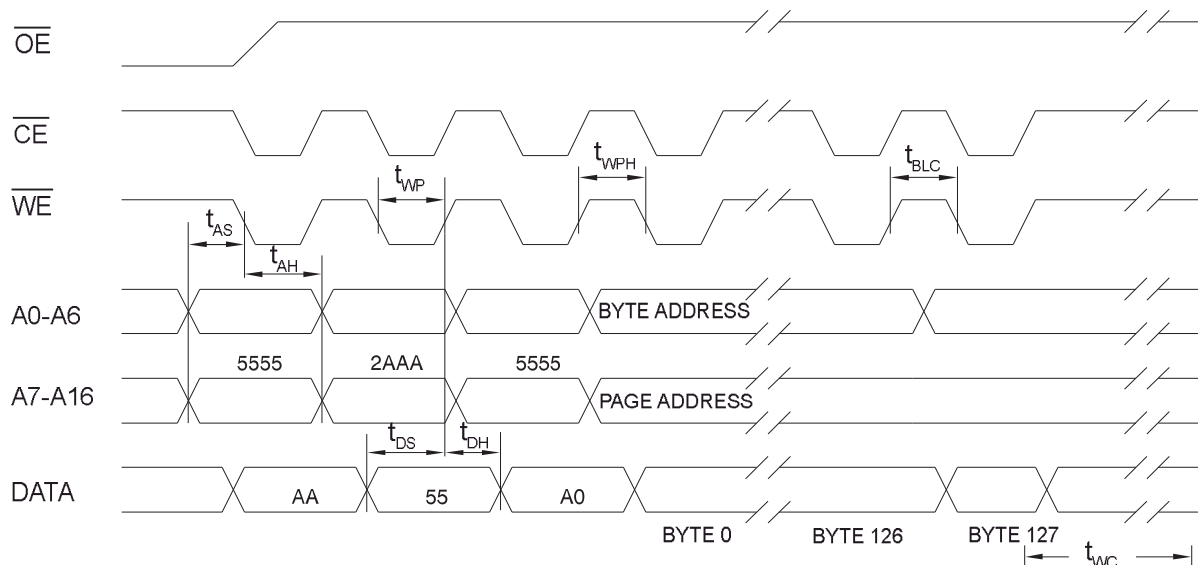
1. Data format: I/O7-I/O0 (Hex); Address format: A16-A0 (Hex).
2. Write-Protect state will be activated at end of write even if no other data is loaded.
3. 1 to 128 bytes of data are loaded.

5.12 Software Data Protection Disable Algorithm⁽¹⁾

**Note:**

1. Data format: I/O7-I/O0 (Hex); Address format: A16-A0 (Hex).
2. Write-Protect state will be deactivated at end of write period even if no other data is loaded.
3. 1 to 128 bytes of data are loaded.

5.13 Software Protected Program Cycle Waveform^(1,2,3)



Note:

1. $A0-A16$ must conform to the addressing sequence for the first 3 bytes as shown above.
2. After the command sequence has been issued and a page write operation follows, the page address inputs ($A7-A16$) must be the same for each high-to-low transition of \overline{WE} (or \overline{CE}).
3. \overline{OE} must be high only when \overline{WE} and \overline{CE} are both low.

5.14 Data Polling Characteristics⁽¹⁾

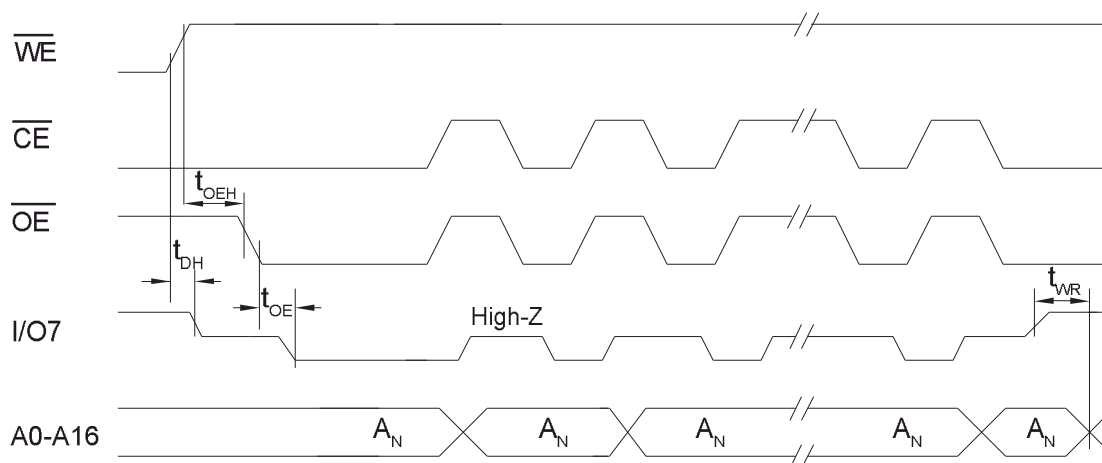
Table 5-5. Data Polling Characteristics

Parameter	Symbol	Minimum	Typical	Maximum	Units
Data Hold Time	t_{DH}	10	—	—	ns
\overline{OE} Hold Time	t_{OEH}	10	—	—	ns
\overline{OE} to Output Delay ⁽²⁾	t_{OE}	—	—	—	ns
Write Recovery Time	t_{WR}	0	—	—	ns

Note:

1. These parameters are characterized and not 100% tested.
2. See [AC Read Characteristics](#).

5.15 Data Polling Waveforms



5.16 Toggle Bit Characteristics⁽¹⁾

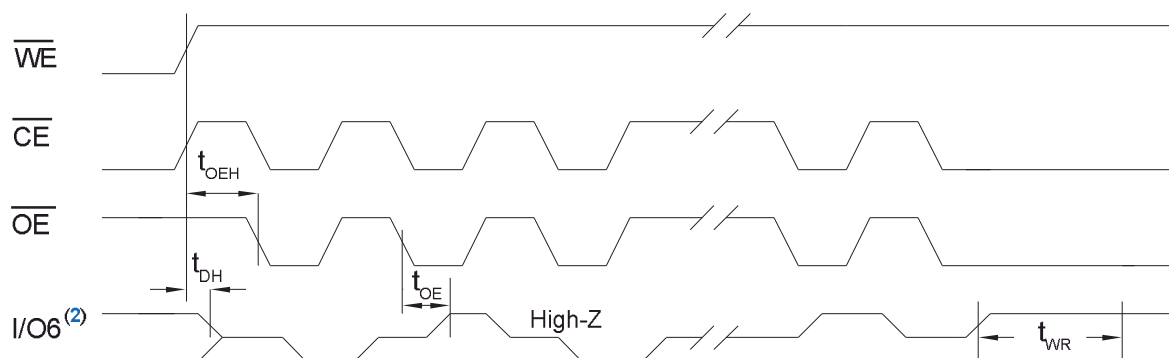
Table 5-6. Toggle Bit Characteristics

Parameter	Symbol	Minimum	Typical	Maximum	Units
Data Hold Time	t_{DH}	10	—	—	ns
\overline{OE} Hold Time	$t_{OE\overline{H}}$	10	—	—	ns
\overline{OE} to Output Delay ⁽²⁾	t_{OE}	—	—	—	ns
\overline{OE} High Pulse ⁽²⁾	t_{OEHP}	150	—	—	ns
Write Recovery Time	t_{WR}	0	—	—	ns

Note:

1. These parameters are characterized and not 100% tested.
2. See [AC Read Characteristics](#).

5.17 Toggle Bit Waveforms



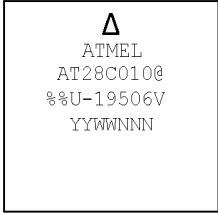
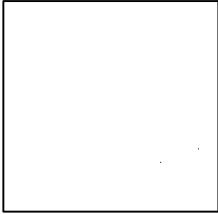
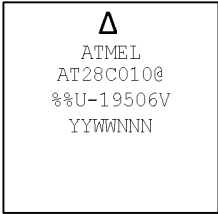
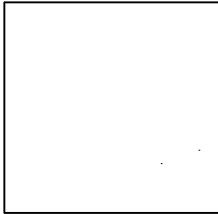
Note:

1. Toggling either \overline{OE} or \overline{CE} or both \overline{OE} and \overline{CE} will operate toggle bit.
2. Beginning and ending state of I/O6 will vary.
3. Any address location may be used but the address should not vary.

6. Packaging Information

6.1 Package Marking Information

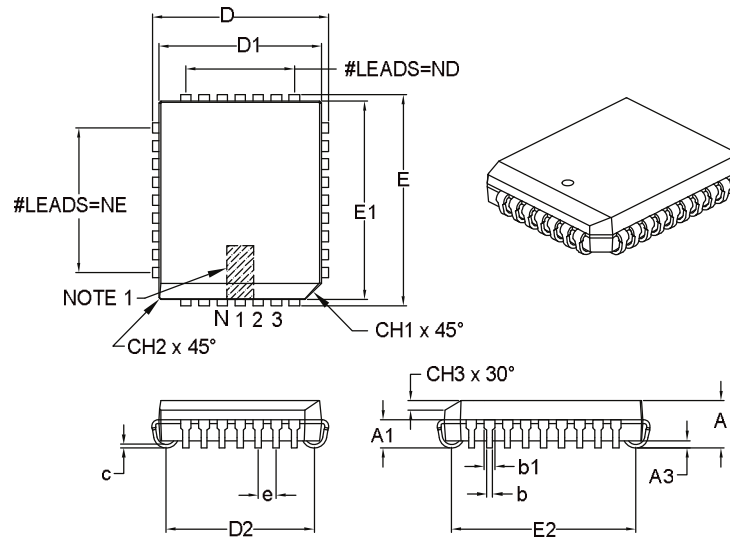
AT28C010: Package Marking Information (Industrial Grade)

32-Lead TSOP		32-Lead PLCC	
Topside	Backside	Topside	Backside
			

	%% = Access Time 12: 120 ns 15: 150 ns	@ = Write Endurance Rating Blank: Standard (10K) E: Extended (100K)	
		Lot Trace Code	
		YYWWNNN: Lot Trace Code	

32-Lead Plastic Leaded Chip Carrier (L) – Rectangle [PLCC]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



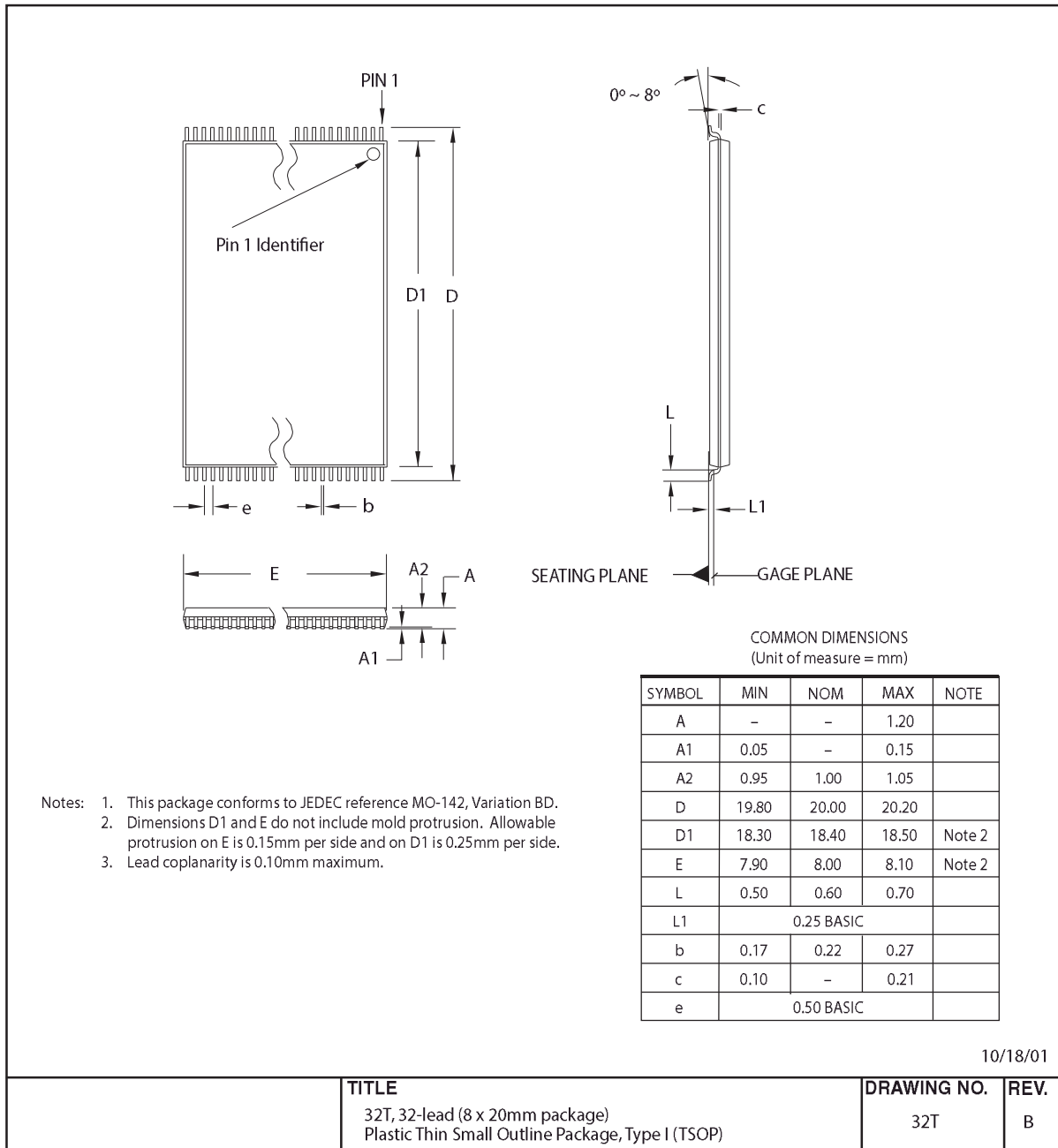
Dimension	Units	INCHES		
		MIN	NOM	MAX
Number of Pins	N		32	
Pitch	e		.050	
Pins along Length	ND		7	
Pins along Width	NE		9	
Overall Height	A	.125	–	.140
Contact Height	A1	.060	–	.095
Standoff §	A3	.015	–	–
Corner Chamfer	CH1	.042	–	.048
Chamfers	CH2	–	–	.020
Side Chamfer Height	CH3	.023	–	.029
Overall Length	D	.485	–	.495
Overall Width	E	.585	–	.595
Molded Package Length	D1	.447	–	.453
Molded Package Width	E1	.547	–	.553
Footprint Length	D2	.376	–	.446
Footprint Width	E2	.476	–	.546
Lead Thickness	c	.008	–	.013
Upper Lead Width	b1	.026	–	.032
Lower Lead Width	b	.013	–	.021

Notes:

- Pin 1 visual index feature may vary, but must be located within the hatched area.
- § Significant Characteristic.
- Dimensions D1 and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" per side.
- Dimensioning and tolerancing per ASME Y14.5M.

Microchip Technology Drawing C04-023B

32-Lead (8 x 20 mm package) Plastic Thin Small Outline Package, Type I (TSOP)



Note:

For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>.

7. Revision History

Revision A (March 2020)

Updated to the Microchip template. Microchip DS20006331 replaces Atmel document 0353. Added marking details and product identification system details.

Atmel Document 0353 Revision I (August 2009)

Updated AC Characteristics and ordering information.

Atmel Document 0353 Revision I (July 2009)

Added a revision history page and update this version "I" with the changes (AC Characteristics and ordering info from the word file).

The Microchip Website

Microchip provides online support via our website at <http://www.microchip.com/>. This website is used to make files and information easily available to customers. Some of the content available includes:

- **Product Support** – Data sheets and errata, application notes and sample programs, design resources, user's guides and hardware support documents, latest software releases and archived software
- **General Technical Support** – Frequently Asked Questions (FAQs), technical support requests, online discussion groups, Microchip design partner program member listing
- **Business of Microchip** – Product selector and ordering guides, latest Microchip press releases, listing of seminars and events, listings of Microchip sales offices, distributors and factory representatives

Product Change Notification Service

Microchip's product change notification service helps keep customers current on Microchip products. Subscribers will receive email notification whenever there are changes, updates, revisions or errata related to a specified product family or development tool of interest.

To register, go to <http://www.microchip.com/pcn> and follow the registration instructions.

Customer Support

Users of Microchip products can receive assistance through several channels:

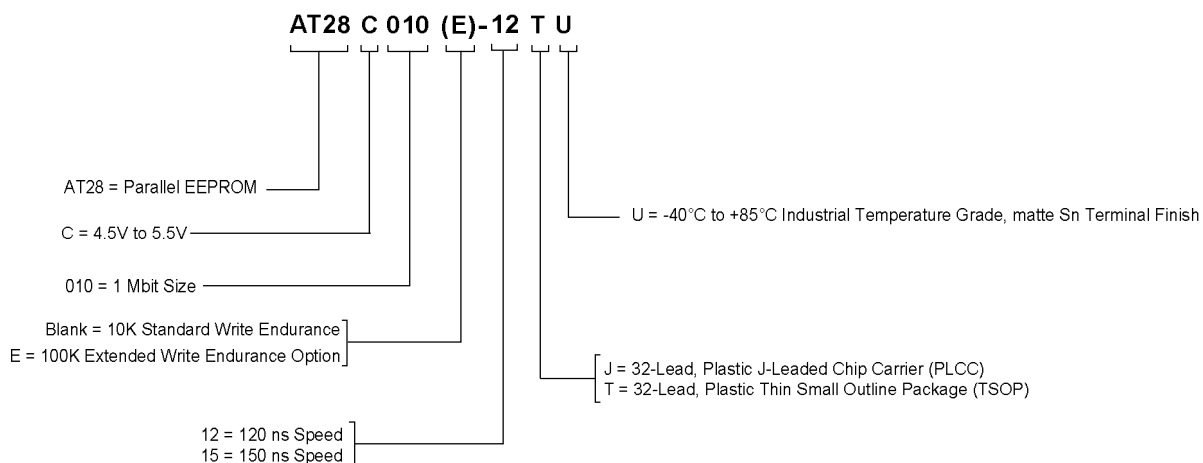
- Distributor or Representative
- Local Sales Office
- Embedded Solutions Engineer (ESE)
- Technical Support

Customers should contact their distributor, representative or ESE for support. Local sales offices are also available to help customers. A listing of sales offices and locations is included in this document.

Technical support is available through the website at: <http://www.microchip.com/support>

Product Identification System

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.



Examples

Table 11-1. AT28C010 Ordering Information

Ordering Code	Package Number	t _{ACC} (ns)	Quantity	Operating Range
AT28C010-12JU	P3X	120	Tube 32	Industrial (-40°C to +85°C)
AT28C010-12JU-T	P3X		Reel 750	
AT28C010-12TU	32T		Tray 156	
AT28C010-12TU-T	32T		Reel 1500	
AT28C010-15JU	P3X	150	Tube 32	
AT28C010-15JU-T	P3X		Reel 750	
AT28C010-15TU	32T		Tray 156	
AT28C010-15TU-T	32T		Reel 1500	

Table 11-2. AT28C010E Ordering Information

Ordering Code	Package Number	t _{ACC} (ns)	Quantity	Operating Range
AT28C010E-12JU	P3X	120	Tube 32	Industrial (-40°C to +85°C)
AT28C010E-12JU-T	P3X		Reel 750	
AT28C010E-12TU	32T		Tray 156	
AT28C010E-12TU-T	32T		Reel 1500	
AT28C010E-15JU	P3X	150	Tube 32	
AT28C010E-15JU-T	P3X		Reel 750	
AT28C010E-15TU	32T		Tray 156	
AT28C010E-15TU-T	32T		Reel 1500	

Package Types	
P3X	32-Lead, Plastic J-leaded Chip Carrier (PLCC)
32T	32-Lead, Plastic Thin Small Outline Package (TSOP)
Options	
Blank	Standard Device: Endurance = 10K Write Cycles; Write Time 10 ms
E	High Endurance Option: Endurance = 100K Write Cycles

Microchip Devices Code Protection Feature

Note the following details of the code protection feature on Microchip devices:

- Microchip products meet the specification contained in their particular Microchip Data Sheet.
- Microchip believes that its family of products is one of the most secure families of its kind on the market today, when used in the intended manner and under normal conditions.
- There are dishonest and possibly illegal methods used to breach the code protection feature. All of these methods, to our knowledge, require using the Microchip products in a manner outside the operating specifications contained in Microchip's Data Sheets. Most likely, the person doing so is engaged in theft of intellectual property.
- Microchip is willing to work with the customer who is concerned about the integrity of their code.
- Neither Microchip nor any other semiconductor manufacturer can guarantee the security of their code. Code protection does not mean that we are guaranteeing the product as "unbreakable."

Code protection is constantly evolving. We at Microchip are committed to continuously improving the code protection features of our products. Attempts to break Microchip's code protection feature may be a violation of the Digital Millennium Copyright Act. If such acts allow unauthorized access to your software or other copyrighted work, you may have a right to sue for relief under that Act.

Legal Notice

Information contained in this publication regarding device applications and the like is provided only for your convenience and may be superseded by updates. It is your responsibility to ensure that your application meets with your specifications. MICROCHIP MAKES NO REPRESENTATIONS OR WARRANTIES OF ANY KIND WHETHER EXPRESS OR IMPLIED, WRITTEN OR ORAL, STATUTORY OR OTHERWISE, RELATED TO THE INFORMATION, INCLUDING BUT NOT LIMITED TO ITS CONDITION, QUALITY, PERFORMANCE, MERCHANTABILITY OR FITNESS FOR PURPOSE. Microchip disclaims all liability arising from this information and its use. Use of Microchip devices in life support and/or safety applications is entirely at the buyer's risk, and the buyer agrees to defend, indemnify and hold harmless Microchip from any and all damages, claims, suits, or expenses resulting from such use. No licenses are conveyed, implicitly or otherwise, under any Microchip intellectual property rights unless otherwise stated.

Trademarks

The Microchip name and logo, the Microchip logo, Adaptec, AnyRate, AVR, AVR logo, AVR Freaks, BesTime, BitCloud, chipKIT, chipKIT logo, CryptoMemory, CryptoRF, dsPIC, FlashFlex, flexPWR, HELDO, IGLOO, JukeBlox, KeeLoq, Klear, LANCheck, LinkMD, maXStylus, maXTouch, MediaLB, megaAVR, Microsemi, Microsemi logo, MOST, MOST logo, MPLAB, OptoLyzer, PackTime, PIC, picoPower, PICSTART, PIC32 logo, PolarFire, Prochip Designer, QTouch, SAM-BA, SenGenuity, SpyNIC, SST, SST Logo, SuperFlash, Symmetricom, SyncServer, Tachyon, TempTrackr, TimeSource, tinyAVR, UNI/O, Vectron, and XMEGA are registered trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

APT, ClockWorks, The Embedded Control Solutions Company, EtherSynch, FlashTec, Hyper Speed Control, HyperLight Load, IntelliMOS, Libero, motorBench, mTouch, Powermite 3, Precision Edge, ProASIC, ProASIC Plus,

ProASIC Plus logo, Quiet-Wire, SmartFusion, SyncWorld, Temux, TimeCesium, TimeHub, TimePictra, TimeProvider, Vite, WinPath, and ZL are registered trademarks of Microchip Technology Incorporated in the U.S.A.

Adjacent Key Suppression, AKS, Analog-for-the-Digital Age, Any Capacitor, AnyIn, AnyOut, BlueSky, BodyCom, CodeGuard, CryptoAuthentication, CryptoAutomotive, CryptoCompanion, CryptoController, dsPICDEM, dsPICDEM.net, Dynamic Average Matching, DAM, ECAN, EtherGREEN, In-Circuit Serial Programming, ICSP, INICnet, Inter-Chip Connectivity, JitterBlocker, KleerNet, KleerNet logo, memBrain, Mindi, MiWi, MPASM, MPF, MPLAB Certified logo, MPLIB, MPLINK, MultiTRAK, NetDetach, Omniscient Code Generation, PICDEM, PICDEM.net, PICkit, PICtail, PowerSmart, PureSilicon, QMatrix, REAL ICE, Ripple Blocker, SAM-ICE, Serial Quad I/O, SMART-I.S., SQI, SuperSwitcher, SuperSwitcher II, Total Endurance, TSHARC, USBCheck, VariSense, ViewSpan, WiperLock, Wireless DNA, and ZENA are trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

SQTP is a service mark of Microchip Technology Incorporated in the U.S.A.

The Adaptec logo, Frequency on Demand, Silicon Storage Technology, and Symmcom are registered trademarks of Microchip Technology Inc. in other countries.

GestIC is a registered trademark of Microchip Technology Germany II GmbH & Co. KG, a subsidiary of Microchip Technology Inc., in other countries.

All other trademarks mentioned herein are property of their respective companies.

© 2020, Microchip Technology Incorporated, Printed in the U.S.A., All Rights Reserved.

ISBN: 978-1-5224-5808-1

AMBA, Arm, Arm7, Arm7TDMI, Arm9, Arm11, Artisan, big.LITTLE, Cordio, CoreLink, CoreSight, Cortex, DesignStart, DynamiQ, Jazelle, Keil, Mali, Mbed, Mbed Enabled, NEON, POP, RealView, SecurCore, Socrates, Thumb, TrustZone, ULINK, ULINK2, ULINK-ME, ULINK-PLUS, ULINKpro, μ Vision, Versatile are trademarks or registered trademarks of Arm Limited (or its subsidiaries) in the US and/or elsewhere.

Quality Management System

For information regarding Microchip's Quality Management Systems, please visit <http://www.microchip.com/quality>.

Worldwide Sales and Service

AMERICAS	ASIA/PACIFIC	ASIA/PACIFIC	EUROPE
Corporate Office 2355 West Chandler Blvd. Chandler, AZ 85224-6199 Tel: 480-792-7200 Fax: 480-792-7277 Technical Support: http://www.microchip.com/support Web Address: http://www.microchip.com	Australia - Sydney Tel: 61-2-9868-6733 China - Beijing Tel: 86-10-8569-7000 China - Chengdu Tel: 86-28-8665-5511 China - Chongqing Tel: 86-23-8980-9588 China - Dongguan Tel: 86-769-8702-9880 China - Guangzhou Tel: 86-20-8755-8029 China - Hangzhou Tel: 86-571-8792-8115 China - Hong Kong SAR Tel: 852-2943-5100 China - Nanjing Tel: 86-25-8473-2460 China - Qingdao Tel: 86-532-8502-7355 China - Shanghai Tel: 86-21-3326-8000 China - Shenyang Tel: 86-24-2334-2829 China - Shenzhen Tel: 86-755-8864-2200 China - Suzhou Tel: 86-186-6233-1526 China - Wuhan Tel: 86-27-5980-5300 China - Xian Tel: 86-29-8833-7252 China - Xiamen Tel: 86-592-2388138 China - Zhuhai Tel: 86-756-3210040	India - Bangalore Tel: 91-80-3090-4444 India - New Delhi Tel: 91-11-4160-8631 India - Pune Tel: 91-20-4121-0141 Japan - Osaka Tel: 81-6-6152-7160 Japan - Tokyo Tel: 81-3-6880-3770 Korea - Daegu Tel: 82-53-744-4301 Korea - Seoul Tel: 82-2-554-7200 Malaysia - Kuala Lumpur Tel: 60-3-7651-7906 Malaysia - Penang Tel: 60-4-227-8870 Philippines - Manila Tel: 63-2-634-9065 Singapore Tel: 65-6334-8870 Taiwan - Hsin Chu Tel: 886-3-577-8366 Taiwan - Kaohsiung Tel: 886-7-213-7830 Taiwan - Taipei Tel: 886-2-2508-8600 Thailand - Bangkok Tel: 66-2-694-1351 Vietnam - Ho Chi Minh Tel: 84-28-5448-2100	Austria - Wels Tel: 43-7242-2244-39 Fax: 43-7242-2244-393 Denmark - Copenhagen Tel: 45-4485-5910 Fax: 45-4485-2829 Finland - Espoo Tel: 358-9-4520-820 France - Paris Tel: 33-1-69-53-63-20 Fax: 33-1-69-30-90-79 Germany - Garching Tel: 49-8931-9700 Germany - Haan Tel: 49-2129-3766400 Germany - Heilbronn Tel: 49-7131-72400 Germany - Karlsruhe Tel: 49-721-625370 Germany - Munich Tel: 49-89-627-144-0 Fax: 49-89-627-144-44 Germany - Rosenheim Tel: 49-8031-354-560 Israel - Ra'anana Tel: 972-9-744-7705 Italy - Milan Tel: 39-0331-742611 Fax: 39-0331-466781 Italy - Padova Tel: 39-049-7625286 Netherlands - Drunen Tel: 31-416-690399 Fax: 31-416-690340 Norway - Trondheim Tel: 47-72884388 Poland - Warsaw Tel: 48-22-3325737 Romania - Bucharest Tel: 40-21-407-87-50 Spain - Madrid Tel: 34-91-708-08-90 Fax: 34-91-708-08-91 Sweden - Gothenberg Tel: 46-31-704-60-40 Sweden - Stockholm Tel: 46-8-5090-4654 UK - Wokingham Tel: 44-118-921-5800 Fax: 44-118-921-5820

SYST-18OXPD053 - Data Sheet - AT28C010 Industrial - Complete Datasheet

Affected Catalog Part Numbers(CPN)

AT28C010-12DK-E
AT28C010-12DK-GRC
AT28C010-12DK-MQ
AT28C010-12DK-SV
AT28C010-12DM/883
AT28C010-12EM/883
AT28C010-12FM/883
AT28C010-12FM/883-341
AT28C010-12JU
AT28C010-12JU-076
AT28C010-12JU-235
AT28C010-12JU-T
AT28C010-12LM/883
AT28C010-12TU
AT28C010-12TU-T
AT28C010-12UM/883
AT28C010-15DM/883
AT28C010-15EM/883
AT28C010-15FM/883
AT28C010-15JU
AT28C010-15JU-235
AT28C010-15JU-T
AT28C010-15LM/883
AT28C010-15TU
AT28C010-15TU-T
AT28C010-15UM/883
AT28C010-20DM/883
AT28C010-20EM/883
AT28C010-20FM/883
AT28C010-20LM/883
AT28C010-20UM/883
AT28C010-25DM/883
AT28C010-25FM/883
AT28C010-25LM/883
AT28C010-DM-001
AT28C010-DWFM
AT28C010-DWFM-526
AT28C010-EM-027
AT28C010-EM-065
AT28C010-EM-526
AT28C010-EM-896
AT28C010-WM

AT28C010-WM-001
AT28C010-WM-027
AT28C010-WM-065
AT28C010-WM-896
AT28C010E-12DM/883
AT28C010E-12DM/883-341
AT28C010E-12EM-370
AT28C010E-12EM/883
AT28C010E-12FM/883
AT28C010E-12JU
AT28C010E-12JU-235
AT28C010E-12JU-341
AT28C010E-12JU-T
AT28C010E-12LM/883
AT28C010E-12TU
AT28C010E-12TU-T
AT28C010E-12UM/883
AT28C010E-15DM/883
AT28C010E-15JU
AT28C010E-15JU-235
AT28C010E-15JU-T
AT28C010E-15LM/883
AT28C010E-15TU
AT28C010E-15TU-T